

High Performance Schottky Rectifier, 1 A

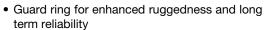


SMA (DO-214AC)

| PRIMARY CHARACTERISTICS | | | | |
|----------------------------------|------------------|--|--|--|
| I _{F(AV)} | 1 A | | | |
| V _R | 60 V | | | |
| V _F at I _F | 0.57 V | | | |
| I _{RM} | 7.5 mA at 125 °C | | | |
| T _J max. | 150 °C | | | |
| E _{AS} | 2.0 mJ | | | |
| Package | SMA (DO-214AC) | | | |
| Circuit configuration | Single | | | |

FEATURES

Low forward voltage drop





- Small footprint, surface mountable
- High frequency operation
- Meets MSL level 1, per J-STD-020, LF maximum peak of 260 °C
- Meets JESD 201 class 2 whisker test
- AEC-Q101 qualified
- Material categorization: for definitions of compliance please see <u>www.vishay.com/doc?99912</u>

DESCRIPTION / APPLICATIONS

The VS-10MQ060HM3 surface mount Schottky rectifier has been designed for applications requiring low forward drop and very small foot prints on PC boards. Typical applications are in disk drives, switching power supplies, converters, freewheeling diodes, battery charging, and reverse battery protection.

| MAJOR RATINGS AND CHARACTERISTICS | | | | |
|-----------------------------------|---|-------------|-------|--|
| SYMBOL | CHARACTERISTICS | VALUES | UNITS | |
| I _{F(AV)} | Rectangular waveform | 1 | A | |
| V _{RRM} | | 60 | V | |
| I _{FSM} | t _p = 5 μs sine | 40 | A | |
| V _F | 1.5 A _{pk} , T _J = 125 °C | 0.63 | V | |
| TJ | Range | -55 to +150 | °C | |

| VOLTAGE RATINGS | | | |
|--------------------------------------|-----------|---------------|-------|
| PARAMETER | SYMBOL | VS-10MQ060HM3 | UNITS |
| Maximum DC reverse voltage | V_{R} | 60 | V |
| Maximum working peak reverse voltage | V_{RWM} | 60 | V |

| ABSOLUTE MAXIMUM RATINGS | | | | | |
|--|--------------------|--|--|--------|-------|
| PARAMETER | SYMBOL | TEST CONDI | TIONS | VALUES | UNITS |
| Maximum average forward current | | 50 % duty cycle at T_L = 120 °C On PC board 9 mm ² island (0.013 mm thick copper pad are | . • | 1.5 | А |
| See fig. 4 | I _{F(AV)} | 50 % duty cycle at T_L = 129 °C On PC board 9 mm ² island (0.013 mm thick copper pad are | . • | 1 | A |
| Maximum peak one cycle | | 5 μs sine or 3 μs rect. pulse | Following any rated | 40 | |
| non-repetitive surge current See fig. 6 | I _{FSM} | 10 ms sine or 6 ms rect. pulse | load condition and with rated V _{RRM} applied | 10 | А |
| Non-repetitive avalanche energy | E _{AS} | $T_J = 25 ^{\circ}\text{C}, I_{AS} = 1 \text{A}, L = 4 \text{mH}$ | | 2.0 | mJ |
| Repetitive avalanche current | I _{AR} | Current decaying linearly to zero in 1 μ s Frequency limited by T _J maximum V _A = 1.5 x V _R typical | | 1.0 | Α |



| ELECTRICAL SPECIFICATIONS | | | | | |
|---------------------------------|--------------------------------|---|--------------------------|--------|-------|
| PARAMETER | SYMBOL | TEST CONDITIONS | | VALUES | UNITS |
| | V (1) | 1 A | T _J = 25 °C | 0.63 | V |
| Maximum forward voltage drop | | 1.5 A | | 0.71 | |
| See fig. 1 | V _{FM} ⁽¹⁾ | 1 A | T _{.1} = 125 °C | 0.57 | V |
| | | 1.5 A | 1J = 125 C | 0.63 | |
| Maximum reverse leakage current | ı | T _J = 25 °C | V Dated V | 0.5 | A |
| See fig. 2 | I _{RM} | $T_J = 125 ^{\circ}\text{C}$ $V_R = \text{Rated } V_R$ | | 7.5 | - mA |
| Threshold voltage | V _{F(TO)} | $T_J = T_J$ maximum | | 0.45 | V |
| Forward slope resistance | r _t | | | 86.8 | mΩ |
| Typical junction capacitance | C _T | V _R = 10 V _{DC} , T _J = 25 °C, test signal = 1 MHz | | 31 | pF |
| Typical series inductance | L _S | Measured lead to lead 5 mm from package body | | 2.0 | nH |
| Maximum voltage rate of change | dV/dt | Rated V _R | | 10 000 | V/µs |

Note

 $^{^{(1)}\,}$ Pulse width = 300 $\mu s,$ duty cycle = 2 %

| PARAMETER | SYMBOL | TEST CONDITIONS | VALUES | UNITS |
|---|--|---------------------------|-------------|-------|
| Maximum junction and storage temperature range | T _J ⁽¹⁾ , T _{Stg} | | -55 to +150 | °C |
| Maximum thermal resistance, junction to ambient | R _{thJA} | DC operation | 80 | °C/W |
| Ain-atin-t | | | 0.07 | g |
| Approximate weight | | 0.002 | OZ. | |
| Marking device | | Case style SMA (DO-214AC) | 11- | 1 |

Note

$$^{(1)} \quad \frac{dP_{tot}}{dT_J} < \frac{1}{R_{thJA}} \quad \text{thermal runaway condition for a diode on its own heatsink}$$

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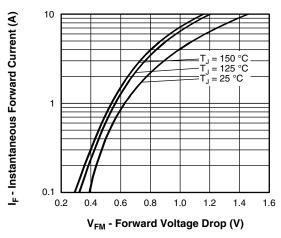


Fig. 1 - Maximum Forward Voltage Drop Characteristics

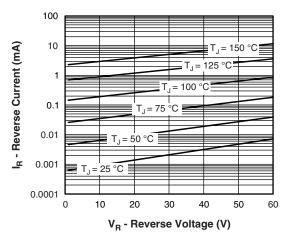


Fig. 2 - Typical Peak Reverse Current vs. Reverse Voltage

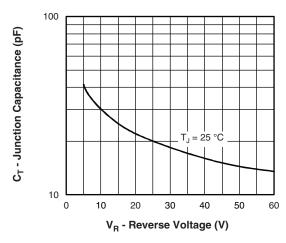
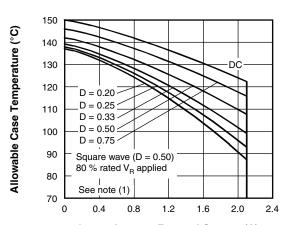


Fig. 3 - Typical Junction Capacitance vs. Reverse Voltage



I_{F(AV)} - Average Forward Current (A)

Fig. 4 - Maximum Average Forward Current vs.
Allowable Lead Temperature

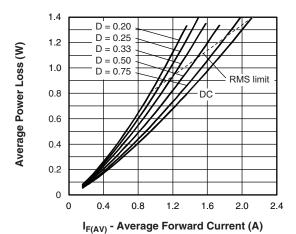


Fig. 5 - Maximum Average Forward Dissipation vs. Average Forward Current

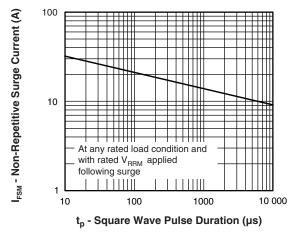


Fig. 6 - Maximum Peak Surge Forward Current vs. Pulse Duration

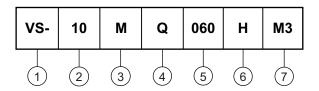
Pd = Forward power loss = $I_{F(AV)} \times V_{FM}$ at $(I_{F(AV)}/D)$ (see fig. 6); Pd_{REV} = Inverse power loss = $V_{R1} \times I_R$ (1 - D); I_R at V_{R1} = 80 % rated V_R

Note (1) Formula used: $T_C = T_J - (Pd + Pd_{REV}) \times R_{thJC}$;



ORDERING INFORMATION TABLE

Device code



Vishay Semiconductors product

2 - Current rating

3 - M = SMA

4 - Q = Schottky "Q" series

Voltage rating (060 = 60 V)

6 - H = AEC-Q101 qualified

7 - Environmental digit:

M3 = Halogen-free, RoHS-compliant and terminations lead (Pb)-free

| ORDERING INFORMATION (Example) | | | | |
|--------------------------------|------------------------|------------------------|------------------------------------|--|
| PREFERRED P/N | PREFERRED PACKAGE CODE | MINIMUM ORDER QUANTITY | PACKAGING DESCRIPTION | |
| VS-10MQ060HM3/5AT | 5AT | 7500 | 13" diameter plastic tape and reel | |

| LINKS TO RELATED DOCUMENTS | | | |
|----------------------------|--------------------------|--|--|
| Dimensions | www.vishay.com/doc?95400 | | |
| Part marking information | www.vishay.com/doc?95403 | | |
| Packaging information | www.vishay.com/doc?95404 | | |
| SPICE model | www.vishay.com/doc?97185 | | |



SMA

DIMENSIONS in inches (millimeters)

DO-214AC (SMA)



Mounting Pad Layout





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